

Title (en)

COMPONENTS FOR HIGH TEMPERATURE APPLICATIONS

Title (de)

BAUTEILE FÜR HOCHTEMPERATURANWENDUNGEN

Title (fr)

ÉLÉMÉNTS POUR DES APPLICATIONS À TEMPÉRATURE ÉLEVÉE

Publication

**EP 2370211 A1 20111005 (DE)**

Application

**EP 09764801 A 20091202**

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- DE 102009044340 A 20091027

Abstract (en)

[origin: WO2010063776A1] The invention relates to a method for producing components, which method is characterized by the following steps: a) making a blank available; b) applying an inorganic-organic hybrid polymer layer to a surface of the blank; c) heating the coated blank to cure the polymer layer; and cooling the coated blank. The invention further relates to a component, especially for the use in domestic appliances, and to the use of said component.

IPC 8 full level

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Citation (search report)

See references of WO 2010063776A1

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